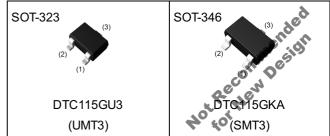


NPN 100mA 50V Digital Transistors (Bias Resistor Built-in Transistors)

Parameter	Value
V _{CEO}	50V
I _C	100mA
R	100kΩ

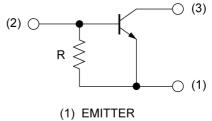
Outline



Features

- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 4) Complementary PNP Types: DTA115G series
- 5) Lead Free/RoHS Compliant.

•Inner circuit



- (2) BASE
- (3) COLLECTOR

Application

Switching circuit, Inverter circuit, Interface circuit,

Driver circuit

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC115GU3	SOT-323 (UMT3)	2021	T106	180	8	3000	K29
DTC115GKA (NRND)	SOT-346 (SMT3)	2928	T146	180	8	3000	K29

• Absolute maximum ratings ($T_a = 25$ °C)

Parameter			Values	Unit
Collector-base voltage			50	V
Collector-emitter voltage			50	V
Emitter-base voltage			5	V
Collector current			100	mA
Dayyar dissination	DTC115GU3	D *1	200	ma\/\/
Power dissipation	P _D *1	200	mW	
Junction temperature	T _j	150	°C	
Range of storage tempera	T _{stg}	-55 to +150	°C	

• Electrical characteristics $(T_a = 25^{\circ}C)$

Darameter	Cymah al	Canditions	Values			l lm:4	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	50	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = 720μA	5	-	-	V	
Collector cut-off current I _C		V _{CB} = 50V	-	-	0.5	μA	
Emitter cut-off current I _{EBO}		V _{EB} = 4V	30	-	58	μA	
Collector-emitter saturation voltage V _{CE(sat}		I _C = 10mA, I _B = 0.5mA	-	-	0.3	V	
DC current gain	$h_{ extsf{FE}}$	$V_{CE} = 5V$, $I_{C} = 5mA$	82	-	-	-	
Emitter-base resistance	R	-	70	100	130	kΩ	
Transition frequency	f _T *2	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz	

^{*1} Each terminal mounted on a reference footprint

● Electrical characteristic curves (T_a =25°C)

Fig.1 Grounded emitter propagation characteristics

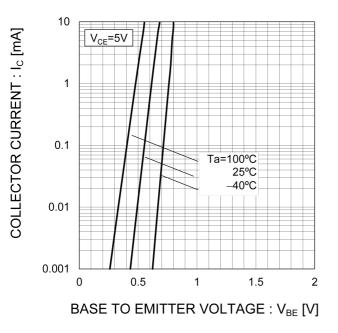


Fig.2 Grounded emitter output characteristics

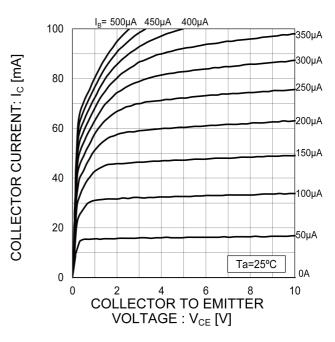


Fig.3 DC Current gain vs. Collector Current

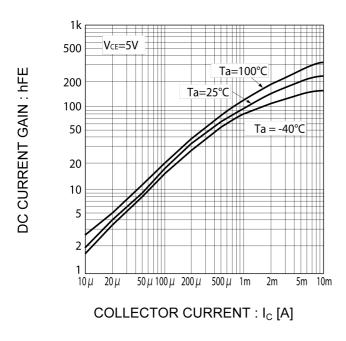
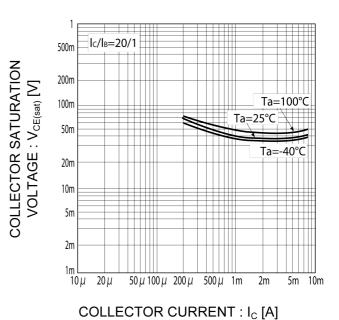
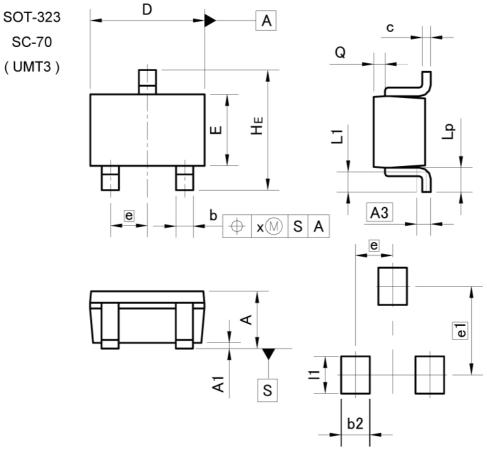


Fig.4 Collector-emitter saturation voltage vs. Collector Current



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

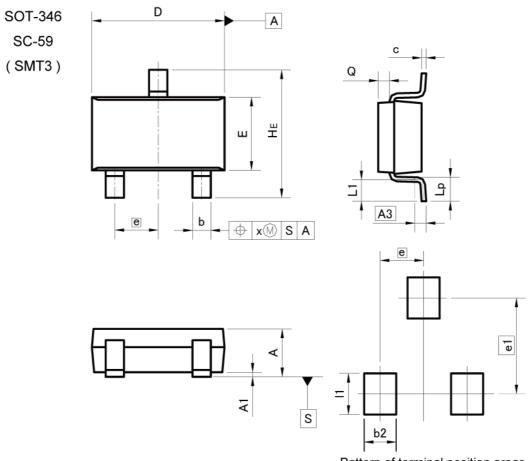
DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.5	25	0.0	10	
b	0.25	0.40	0.010	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	_	0.004	

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	_	0.50	_	0.020
e1	1.55		0.0	61
11	- 0.65		-	0.026

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.00	1.30	0.039	0.051	
A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.0	10	
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	0.9	95	0.037		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х	-	0.10	-	0.004	
У	- 2	0.10	·-	0.004	

DIM	MILIMETERS		INCHES		
	DIM	MIN MAX		MIN	MAX
	b2	-	0.60	_	0.024
	e1	2.10		0.0	83
	11	- 0.90		-	0.035

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
CLASSIII	OL ACOM	CLASS II b	ОГУСОШ
CLASSIV	CLASSⅢ	CLASSIII	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
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- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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